ASSOCIATION CONNECTING ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES* international and Pan-Ame	annockburn, Illinois, /	All rights reserved un entions.	this docum the both level parts,	ent is a declarati the declaration e	on of the substanc ncompasses all lo	es within the manufactur wer level materials for w	rer listed item. Note: if hich the manufacturer	the item is an a has engineering	ssembly with lower responsibility.		
IPC Web Site for Informat	IPC Web Site for Information on IPC-1752 Standard For http://www.ipc.org/IPC-175x Dist			e * Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi				ials and Mfg Information			
Supplier Information											
Company name* Company unique ID				Unique ID Authority			Response Date*				
onsemi	nsemi						2024-05-12				
Contact Name	ontact Name Title - Contact			Phone - Contact*			Email - Contact*				
Product-Env-Stewards Product Enviro Compliance				NA			Product-Env-Stewards@onsemi.com				
ithorized Representative* Title - Representative			Phone - Representative*			Email - Representative*					
Product-Env-Stewards Product Enviro Comp			e NA				Product-Env-Stewards@onsemi.com				
Requester Item Number N	Afr Item Number	mber Mfr Item Name		Effective Date	Version	Manufacturing Site	Weight*	UOM	Unit Type		
Ν	NCP1399ACDR2G	High Perf Current with Integrated HV	Mode Resonant Controller / Drivers	2024-05-12		TH6	132.3281	mg	Each		
Manufacturing Proccess Information											
Terminal Plating / Grid Array Material	I Terminal Base Alloy J		-STD-020 MSL Rating	Peak Process Body Tempera		ture Max Time at Peak	Temperature Number	r of Reflow Cy	cles		
Matte Tin (Sn) - annealed CU Alloy			260	С	30	seconds 3					
Comments											
ATTENTION: MSL 3 Rated item requires Bak	e and Dry Pack (afte	r electrical test)									
For more information regarding material comp	osition please refer t	o page 3									

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted					
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.6562	mg	Supplier	Silicon (Si)	7440-21-3		0.6562	mg
Die Attach	0.875	mg		Epoxy resin	proprietary data		0.0437	mg
			Supplier	4-Methylhexahydrophthalsureanhydrid	19438-60-9		0.0044	mg
			Supplier	Titanium triisostearoylisopropoxide	61417-49-0		0.0437	mg
			Supplier	2,2-dimethyl-1,3-propanediyl dimethacrylate	1985-51-9		0.0437	mg
			Supplier	2-(3,4- Epoxycyclohexyl)ethyltrimethoxysilane	3388-04-3		0.0437	mg
			Supplier	Bisphenol A_Epichlorohydrin Polymer	25068-38-6		0.0044	mg
			Supplier	1,4-Bis(2,3-epoxypropoxy)butane	2425-79-8		0.0437	mg
			Supplier	Isobornyl Acrylate	5888-33-5		0.0437	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		0.6037	mg
Lead Frame	43.7501	mg	Supplier	Silver (Ag)	7440-22-4		0.105	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0831	mg
			Supplier	Iron (Fe)	7439-89-6		1.1331	mg
			Supplier	Copper (Cu)	7440-50-8		42.3676	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0613	mg
Mold Compound-Black	84.2031	mg		Epoxy resin	proprietary data		8.8834	mg
			Supplier	Phenolic Resin	Proprietary Data		2.5261	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		2.5261	mg
			Supplier	Carbon Black (C)	1333-86-4		0.421	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		69.8465	mg
Plating	2.2031	mg	Supplier	Tin (Sn)	7440-31-5		2.2031	mg
Wire Bond	0.6406	mg	Supplier	Palladium (Pd)	7440-05-3		0.0128	mg
			Supplier	Gold (Au)	7440-57-5		0.0032	mg
			Supplier	Copper (Cu)	7440-50-8		0.6246	mg

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).